

Maximum Thermal Resistance

Parameter	Test condition	Symbol	Value	Unit
Junction ambient	1)	R_{thJA}	450	K/W

1) on glass fibre printed board (25 x 20 x 1.5) mm³ plated with 35 µm Cu

Electrical DC Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Collector-emitter cut-off current	$V_{CE} = 25\text{ V}$, $V_{BE} = 0$	I_{CES}			100	µA
Collector-base cut-off current	$V_{CB} = 10\text{ V}$, $I_E = 0$	I_{CBO}			100	nA
Emitter-base cut-off current	$V_{EB} = 2.5\text{ V}$, $I_C = 0$	I_{EBO}			10	µA
Collector-emitter breakdown voltage	$I_C = 1\text{ mA}$, $I_B = 0$	$V_{(BR)CEO}$	15			V
Collector-emitter saturation voltage	$I_C = 10\text{ mA}$, $I_B = 1\text{ mA}$	V_{CEsat}			0.75	V
DC forward current transfer ratio	$V_{CE} = 1\text{ V}$, $I_C = 2\text{ mA}$	h_{FE}	20	100	150	
	$V_{CE} = 1\text{ V}$, $I_C = 25\text{ mA}$	h_{FE}	20			

Electrical AC Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Transition frequency	$V_{CE} = 5\text{ V}$, $I_C = 2\text{ mA}$, $f = 300\text{ MHz}$	f_T		1.5		GHz
	$V_{CE} = 5\text{ V}$, $I_C = 14\text{ mA}$, $f = 300\text{ MHz}$	f_T		2.4		GHz
	$V_{CE} = 5\text{ V}$, $I_C = 25\text{ mA}$, $f = 300\text{ MHz}$	f_T		2.1		GHz
Collector-base capacitance	$V_{CB} = 5\text{ V}$, $f = 1\text{ MHz}$	C_{cb}		0.45		pF
Collector-emitter capacitance	$V_{CE} = 5\text{ V}$, $f = 1\text{ MHz}$	C_{ce}		0.2		pF
Emitter-base capacitance	$V_{EB} = 0.5\text{ V}$, $f = 1\text{ MHz}$	C_{eb}		0.8		pF
Noise figure	$V_{CE} = 5\text{ V}$, $I_C = 2\text{ mA}$, $Z_S = 50\text{ }\Omega$, $f = 800\text{ MHz}$	F		3.5		dB
Power gain	$V_{CE} = 5\text{ V}$, $I_C = 14\text{ mA}$, $Z_S = 50\text{ }\Omega$, $f = 200\text{ MHz}$	G_{pe}		23		dB
	$V_{CE} = 5\text{ V}$, $I_C = 14\text{ mA}$, $Z_S = 50\text{ }\Omega$, $f = 800\text{ MHz}$	G_{pe}		11		dB
Linear output voltage - two tone intermodulation test	$V_{CE} = 5\text{ V}$, $I_C = 14\text{ mA}$, $d_{IM} = 60\text{ dB}$, $f_1 = 806\text{ MHz}$, $f_2 = 810\text{ MHz}$, $Z_S = Z_L = 50\text{ }\Omega$	$V_1 = V_2$		100		mV
Third order intercept point	$V_{CE} = 5\text{ V}$, $I_C = 14\text{ mA}$, $f = 800\text{ MHz}$	IP_3		23		dBm



Common Emitter S-Parameters

$Z_0 = 50 \Omega$, $T_{amb} = 25^\circ\text{C}$, unless otherwise specified

V_{CE}/V	I_C/mA	f/MHz	S11		S21		S12		S22	
			LIN MAG	ANG	LIN MAG	ANG	LIN MAG	ANG	LIN MAG	ANG
				deg		deg		deg		deg
5	2	100	0.89	-30.1	5.92	155.7	0.03	73.7	0.95	-9.2
		300	0.67	-77.7	4.35	121.5	0.06	53.5	0.80	-18.5
		500	0.52	-110.1	3.12	100.8	0.08	47.4	0.71	-20.3
		800	0.42	-141.1	2.13	82.4	0.09	48.7	0.67	-21.6
		1000	0.40	-155.6	1.77	73.5	0.10	51.3	0.67	-23.9
		1200	0.40	-167.6	1.51	66.1	0.11	54.3	0.67	-27.1
		1500	0.41	176.3	1.27	56.0	0.13	59.6	0.66	-32.4
		1800	0.43	162.8	1.09	48.6	0.15	65.5	0.66	-37.3
		2000	0.44	153.6	0.98	45.8	0.18	71.6	0.68	-41.0
5	5	100	0.75	-49.0	11.55	142.9	0.02	66.8	0.88	-14.3
		300	0.48	-106.9	6.36	106.6	0.05	55.0	0.67	-18.9
		500	0.39	-137.3	4.09	90.5	0.06	56.9	0.61	-17.4
		800	0.36	-162.5	2.65	76.0	0.08	61.2	0.60	-17.6
		1000	0.35	-173.1	2.16	68.6	0.10	63.2	0.61	-20.1
		1200	0.37	178.1	1.84	62.2	0.11	65.2	0.61	-23.4
		1500	0.40	165.0	1.51	53.2	0.14	68.1	0.61	-28.9
		1800	0.42	153.7	1.28	46.4	0.16	71.8	0.61	-33.7
		2000	0.43	146.0	1.16	44.2	0.19	76.1	0.64	-37.5
5	10	100	0.58	-70.1	16.31	130.8	0.02	62.7	0.79	-17.5
		300	0.39	-129.4	7.28	98.3	0.04	61.2	0.59	-16.5
		500	0.36	-154.4	4.52	85.2	0.05	64.9	0.56	-14.2
		800	0.36	-174.1	2.88	72.6	0.08	67.6	0.57	-14.8
		1000	0.36	176.8	2.33	65.9	0.10	68.7	0.58	-17.5
		1200	0.38	169.3	1.97	59.8	0.11	70.2	0.59	-21.3
		1500	0.41	159.0	1.61	51.7	0.14	72.7	0.59	-26.7
		1800	0.44	148.4	1.36	45.4	0.17	75.6	0.60	-31.8
		2000	0.46	140.9	1.23	43.0	0.20	79.6	0.62	-35.7
5	15	100	0.49	-84.8	18.25	124.3	0.01	62.8	0.73	-18.0
		300	0.37	-140.9	7.49	94.8	0.03	65.1	0.57	-14.7
		500	0.36	-162.3	4.59	82.8	0.05	68.3	0.55	-12.7
		800	0.37	-179.6	2.91	71.0	0.08	70.4	0.56	-13.5
		1000	0.38	173.1	2.34	64.5	0.09	71.4	0.58	-16.5
		1200	0.40	166.1	1.98	58.8	0.11	72.8	0.58	-20.4
		1500	0.44	155.8	1.61	50.7	0.14	75.2	0.59	-26.2
		1800	0.46	145.8	1.36	44.6	0.17	78.2	0.60	-31.4
		2000	0.48	137.7	1.23	42.4	0.20	81.9	0.62	-35.2
5	20	100	0.44	-96.6	19.07	120.0	0.01	62.0	0.70	-17.6
		300	0.36	-148.7	7.46	92.6	0.03	67.9	0.57	-13.3
		500	0.38	-167.0	4.55	81.4	0.05	70.5	0.55	-11.6
		800	0.39	177.5	2.87	69.9	0.07	72.3	0.57	-13.2
		1000	0.40	169.8	2.31	63.5	0.09	73.3	0.58	-16.3
		1200	0.42	163.8	1.95	57.9	0.11	74.9	0.59	-20.3
		1500	0.46	153.8	1.58	50.1	0.13	77.5	0.59	-26.2
		1800	0.49	143.7	1.34	43.9	0.17	80.4	0.60	-31.4
		2000	0.49	136.1	1.21	41.9	0.20	83.7	0.62	-35.4

Typical Characteristics ($T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

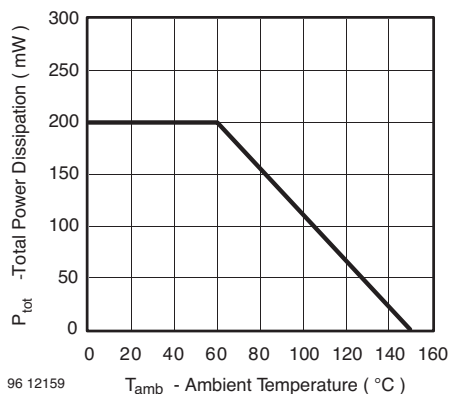


Figure 1. Total Power Dissipation vs. Ambient Temperature

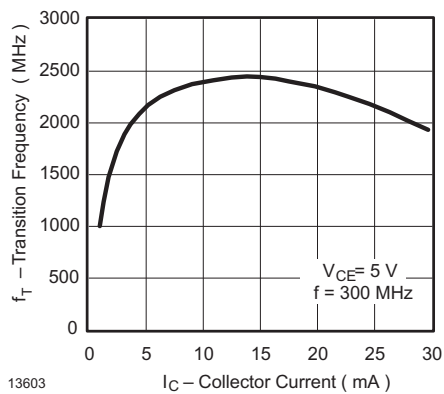


Figure 2. Transition Frequency vs. Collector Current

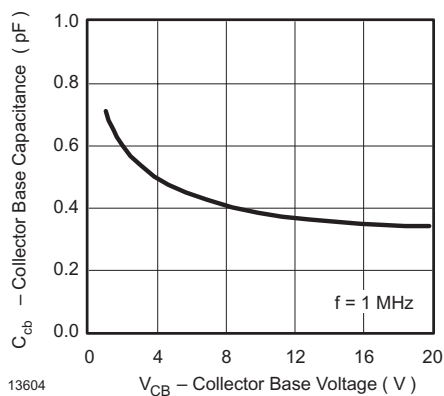
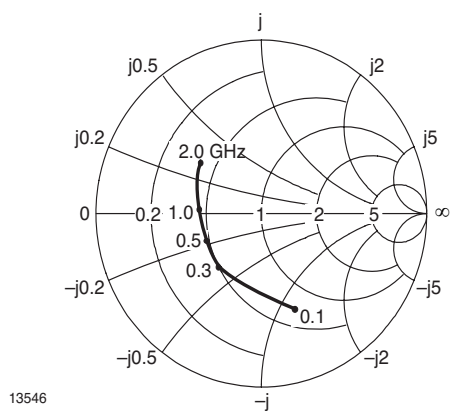


Figure 3. Collector Base Capacitance vs. Collector Base Voltage

$V_{CE} = 5\text{ V}$, $I_C = 10\text{ mA}$, $Z_0 = 50\ \Omega$

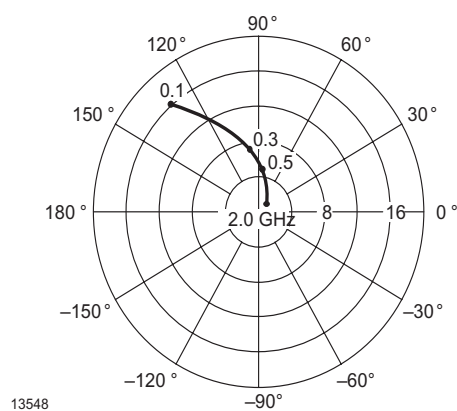
S_{11}



13546

Figure 4. Input Reflection Coefficient

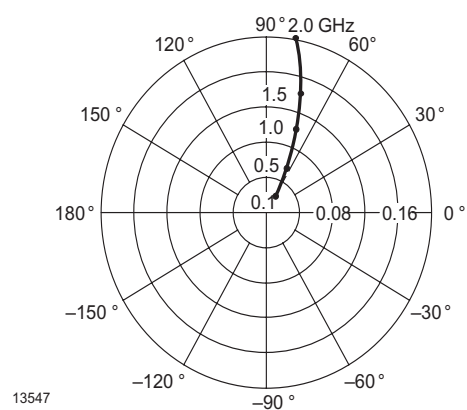
S_{21}



13548

Figure 6. Forward Transmission Coefficient

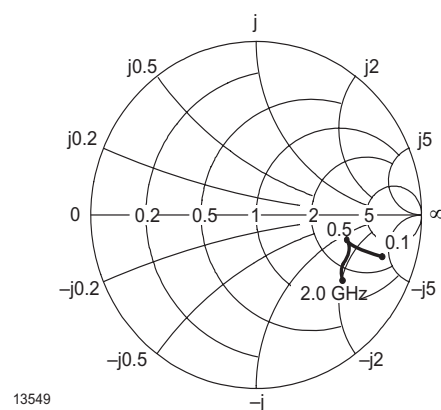
S_{12}



13547

Figure 5. Reverse Transmission Coefficient

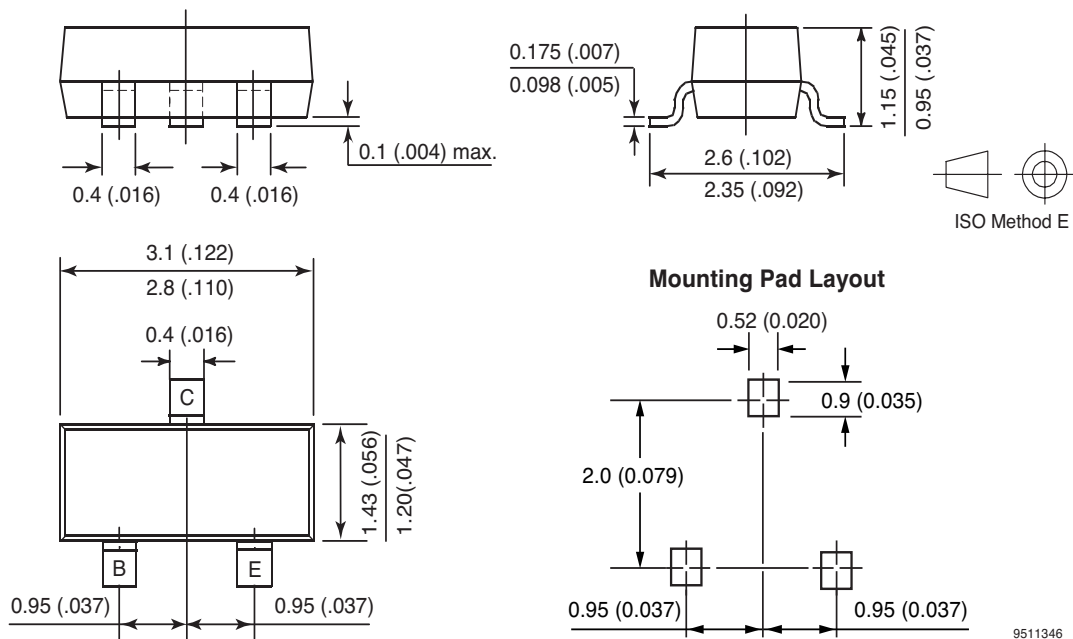
S_{22}



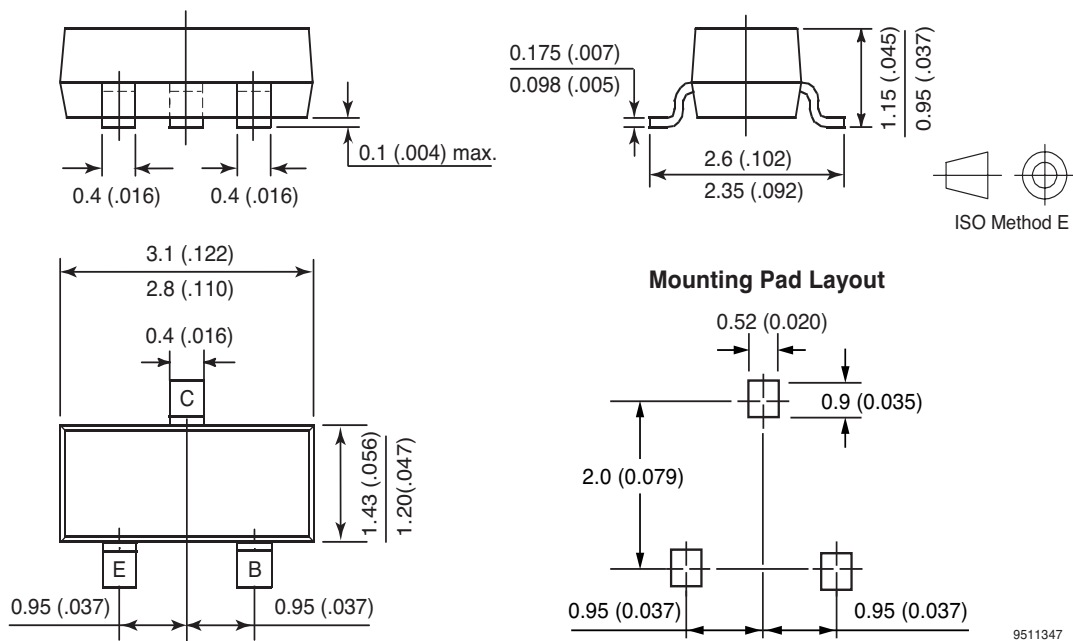
13549

Figure 7. Output Reflection Coefficient

Package Dimensions in mm (Inches)

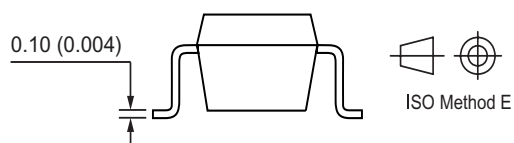
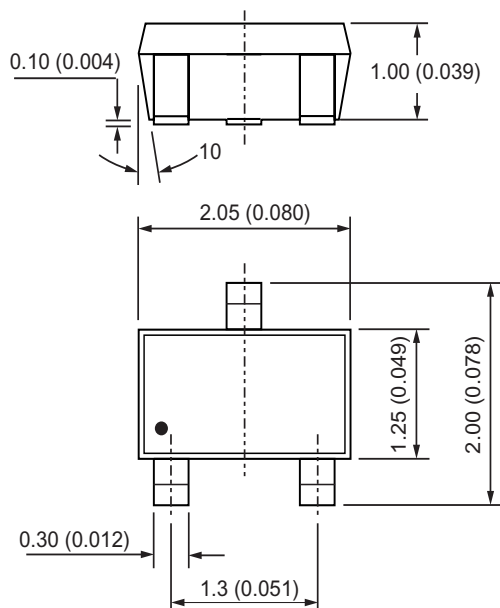


Package Dimensions in mm (Inches)

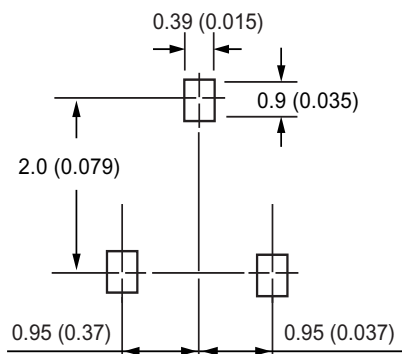




Package Dimensions in mm (Inches)



Mounting Pad Layout



96 12236

Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



Notice

Specifications of the products displayed herein are subject to change without notice. Vishay Intertechnology, Inc., or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Vishay's terms and conditions of sale for such products, Vishay assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of Vishay products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Vishay for any damages resulting from such improper use or sale.